PCN Number:		20180611002			PCN Date: June 14, 2018						
Tit	le: Datasheet fo	r LMT()1-Q1								
Customer Contact: PCN Manage			<u>er</u>			D	Dept:		Quality Services		
Change Type:											
	Assembly Site				Design					Bump Site	
	Assembly Process		\boxtimes	Data Sheet					afer Bump Material		
Щ	Assembly Material				Part number change		<u> </u>	╝		afer Bump Process	
Щ	Mechanical Specification		Щ	Test Site		4 <u> </u>	4		Wafer Fab Site		
Packing/Shipping/Labeling		Ш	Test Process		╀╞	╣		Wafer Fab Materials			
				NI.		Dotoile			Wafer	Fab Process	
Notification Details											
Description of Change: Toyas Instruments Inserporated is appounding an information only notification									nn		
Texas Instruments Incorporated is announcing an information only notification. The product datasheet(s) is being updated as summarized below.											
The following change history provides further details.											
TEXAS											
INSTRUMENTS LMT01-Q1 SNIS192C – NOVEMBER 2016 – REVISED JUNE 2018											
Changes from Revision B (June 2017) to Revision C Page											
Added device stamp to the TO-92 pinout top view											
Changed the TO-92S pin numbers in the <i>Pin Functions</i>											
The datasheet number will be changing.											
D	Device Family			Chan	Change From:			Change To:			
LMT01-Q1			SNIS	SNIS192B			SNIS192C				
These changes may be reviewed at the datasheet links provided.											
http://www.ti.com/product/LMT01-Q1											
Reason for Change:											
To accurately reflect device characteristics.											
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):											
No anticipated impact. This is a specification change announcement only. There are no changes											
	anticipated impact.		s a spe	cifi	cation chang	e announcem	ent	OI	ily. Ille	ere are no changes	
to	anticipated impact. the actual device.	This is	•					OI	ily. Tile	ere are no changes	
to	anticipated impact. the actual device. anges to product	This is	•					OI	ily. Ilik	ere are no changes	
Ch No	anticipated impact. the actual device. anges to product ine.	This is	•					OI	ily. The	ere are no changes	
Ch No	anticipated impact. the actual device. anges to product	This is	•	on i	esulting fro			OI		MT01QDQXTQ1	

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com